Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

- 1. (Currently Amended) A pyrotechnic microsystem (7, 1') comprising a substrate having at least two separate electrical initiation zones of a pyrotechnic material deposited on the substrate, characterized in that the same pyrotechnic material deposit (721, 721', 13) covers both initiation zones, said deposit (721, 721', 13) produced on the substrate having a thickness sufficiently small for the initiation of the pyrotechnic material at one initiation zone to remain localized and not propagate to the other initiation zone, but sufficient to generate a specific gas quantity.
- 2. (Currently Amended) The microsystem (7, 1') as claimed in claim 1, characterized in that wherein the pyrotechnic material deposit (721, 721', 13) is produced with a thickness of less than 100 μ m.
- 3. (Currently Amended) The microsystem (7, 1') as claimed in claim 1-or 2, eharacterized in that wherein the substrate is produced from an assembly of superimposed layers (71, 72, 73, 74 and 10, 11, 12).
- 4. (Currently Amended) The microsystem (7, 1') as claimed in claim 3, characterized in that wherein the pyrotechnic material deposit (721', 13) constitutes one of the superimposed layers (71, 72, 73, 74 and 10, 11, 12).

- 5. (Currently Amended) The microsystem (7, 1') as claimed in claim 4, characterized in that wherein the pyrotechnic material deposit (721', 13) is used as an adhesive for assembly between a layer (72, 10) lying above said deposit (721', 13) and a layer (73, 11) lying below said deposit (721', 13).
- 6. (Currently Amended) The microsystem (7, 1') as claimed in claim 1, eharacterized in that wherein the deposited pyrotechnic material is in the form of a nitrocellulose-based varnish.
- 7. (Currently Amended) The microsystem (7, 1') as claimed in claim 6, characterized in that wherein the varnish is deposited with a thickness of between 5 and 40 µm after drying.
- 8. (Currently Amended) The microsystem (7, 1') as claimed in claim 1, eharacterized in that wherein each of the initiation zones can be produced from an electrical resistance on the substrate.
- 9. (Currently Amended) The microsystem (7, 1') as claimed in claim 1, characterized in that wherein each of the initiation zones can be produced at the point of contact of a conductive finger-(6a,...,6h), connected to an electrical generator (4) on the substrate made of metallic substance, which is also connected to said generator-(4).
- 10. (Currently Amended) The microsystem (7, 1') as claimed in claim 3, characterized in that it comprises comprising a deformable membrane (710, 12) partially delimiting a combustion chamber (720, 2a,..., 2h) intended to receive the gases generated by at least one

part of the pyrotechnic material deposit (721, 721', 13) in contact with one of the initiation zones.

- 11. (Currently Amended) The microsystem (7, 1') as claimed in claim 10, characterized in that it comprises comprising a layer (72, 10) through which an orifice forming the combustion chamber (720, 2a,..., 2h) is formed, said layer (72, 10) being held between the membrane (710, 12), itself forming a layer, and the pyrotechnic substance deposit (721', 13).
- 12. (Currently Amended) A method for fabricating a microsystem (1')-comprising a plurality of adjacent microactuators (1a,...,1h) established on a substrate, each microactuator (1a,...,1h) being capable of having a specific effect owing to the gases generated by the combustion of a pyrotechnic material initiated from an electrical initiation zone associated with each microactuator (1a,...,1h), characterized in that wherein a pyrotechnic material layer (13)-common to all the microactuators (1a,...,1h) is deposited on the substrate with a thickness sufficiently small for the initiation of the pyrotechnic substance in one initiation zone to remain localized and not propagate to the other initiation zone, but sufficient to generate a specific gas quantity.
- 13. (Currently Amended) The method as claimed in claim 12, eharacterized in that wherein it consists only in stacking superimposed layers (10, 11, 12), the pyrotechnic material layer (13) constituting one of the layers of the stack.
- 14. (Currently Amended) The method as claimed in claim 12-or 13, eharacterized in that wherein the pyrotechnic material layer (13)-is deposited with a thickness of less than 100 μm.

15. (Currently Amended) The method as claimed in one of claims 12 to 14, eharacterized in that claim 12, wherein the pyrotechnic material layer (13) is deposited by coating, screen printing, pad printing, immersion or by spraying.